

1H, 2024 Investor Conference

尼得科超眾科技股份有限公司 Nidec Chaun-Choung Technology Corp.

Date: Aug. 27, 2024

Nidec Chaun-Choung Technology Corporation

2024/8/22



Disclaimer

This presentation of NCCI contains forward-looking statements subject to risks and uncertainties. Actual results may differ materially from the contained in the forward-looking statements.

The forward-looking statements in this presentation are the current belief of NCCI as of the date for this release, and NCCI has no obligation to update the forward-looking statements for new information, future events, or otherwise.

Agenda



- Company Profile
- 1H, 2024 Financial Results
- Focus: Market, Products & Technologies
- Q&A

Company Profile



Chairman and CEO : Nagai Junichi

• **Founded :** Dec.14. 1973

Stock Listing: TWSE (ticker: 6230)

Nidec Corporation:

Hold 86.3% shares, as a major shareholder (Jul. 2023).

• **Capital**: NT\$ 863,434 (K)

• **HQ Address :** No. 184-3, Zhongxing N. St., Sanchong Dist.,

New Taipei City 241, Taiwan

Main Business: Heat Sink & Thermal Solutions

WW Factories & Offices



Worldwide Factories & Offices





NCCI Core Competence



Global customers

Long term relationship with DT/AIO/NB/Networking/Server/Automotive/Smart phone customers

Wide range industry portfolio

New technology development for different portfolios

Nidec's synergism

Synergy on new technology, automation and business opportunity

Manufactory Automation

In house design automation capability on heat pipe manufacture, and performance test machine

Strong thermal design capability

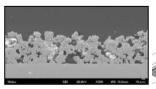
Excellent R&D workforce for total thermal solution

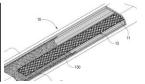
Synergy Advantages



Metallurgy & Wick Technology

Nidec & NCCI with strong basic research Proprietary multi-wick design to support Ultra-thin / Hi-power Thermal Solutions.

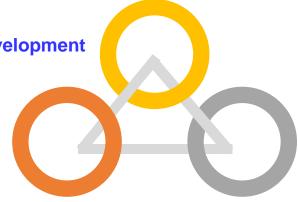




In house Automation Equipment development

Nidec & NCCI collaborate to develop manufacturing automation machine from sample stage to MP stage.





Thermal total solution provider

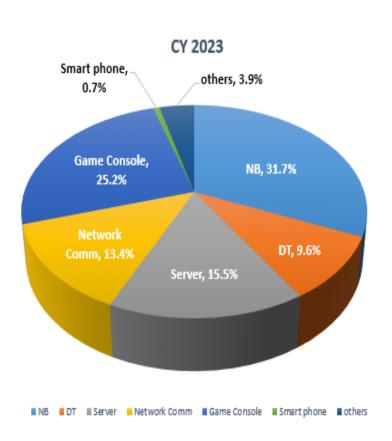
Nidec is good at Fan/Pump active solution and NCCI is good at HP/VC passive solution, collaboration to provide customer total solution with best options.

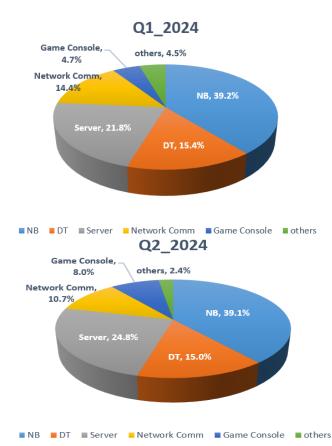




Product share of revenue





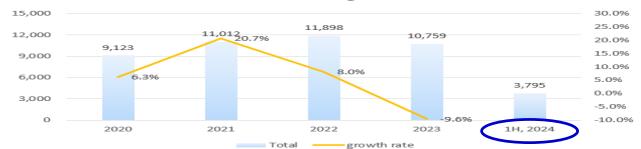


Financial Result-Revenue





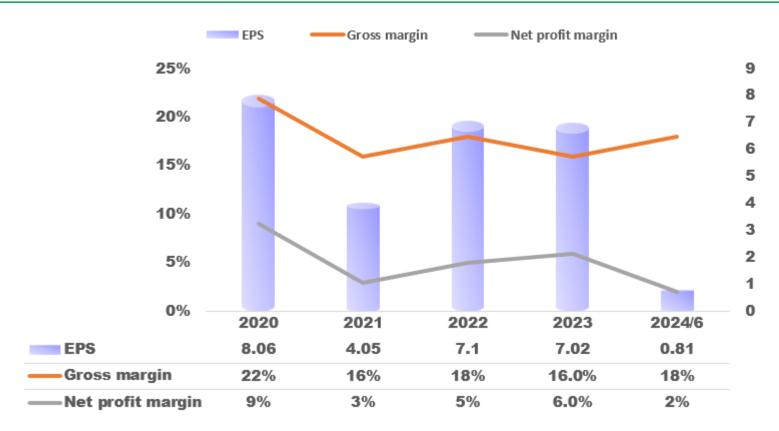




NTD\$: Million

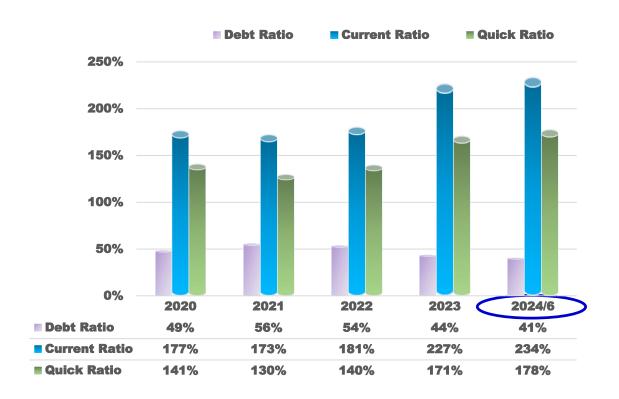
Financial Result-Financial Index I





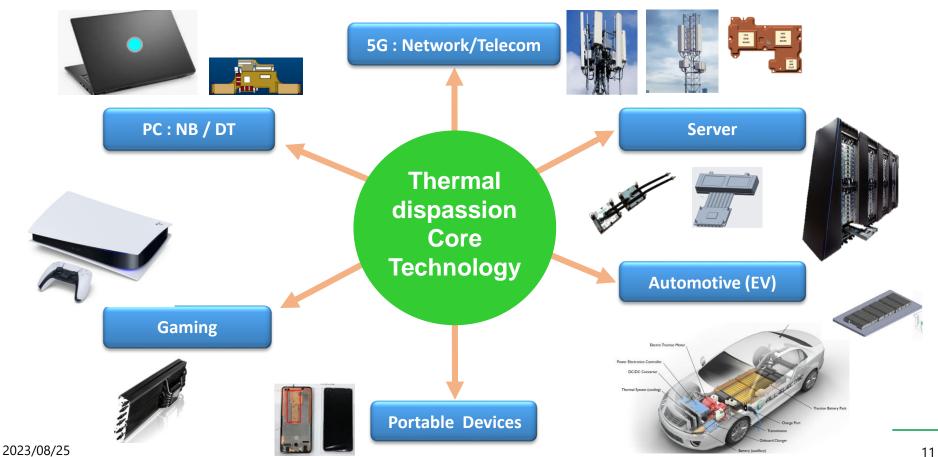
Financial Result-Financial Index II





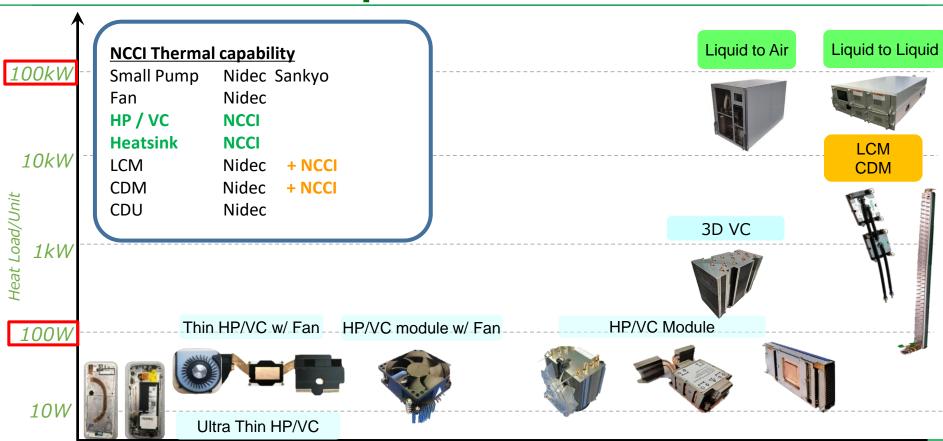
Focus Market





NCCI Product Line-up for Thermal Solutions





Mobile Tablet/Laptop

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Console/Desktop

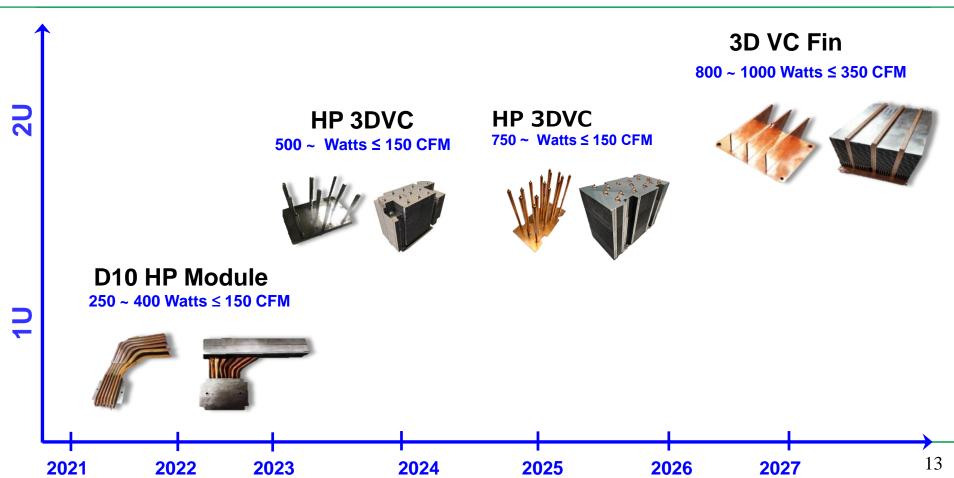
Workstation

Server Data

Data Center

NCCI High Power Thermal Solution Roadmap(A/C)





Application: Notebook/Desktop/AIO/IPC





Air Cooling: Passive / Active



Slim Thermal Solution for Gaming NB Slim VC (1.3mm≤ t ≤2.2mm) for CPU+GPU 170~240 Watts





Application : 5G/6G/HPC

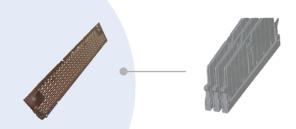


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Ultra-thin Thermal Solution for 5G Smart Phone VC Thickness 0.25mm – 0.35mm



Hi-Power VC Thermal Solution for HPC Server High Heat Flux Vapor Chamber > 80 W/cm²



Application : 5G/6G/HPC



Hi-Power Air Cooling Solution for HPC, Networking

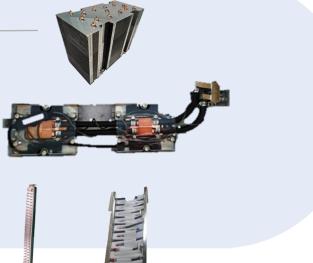
VC module for 350 - 700 Watts

3D VC module for 750 - 1400 Watts

Liquid Cooling Solution for Rack / Tower Server LCM

Liquid Cooling Solution for Rack / Tower Server CDM

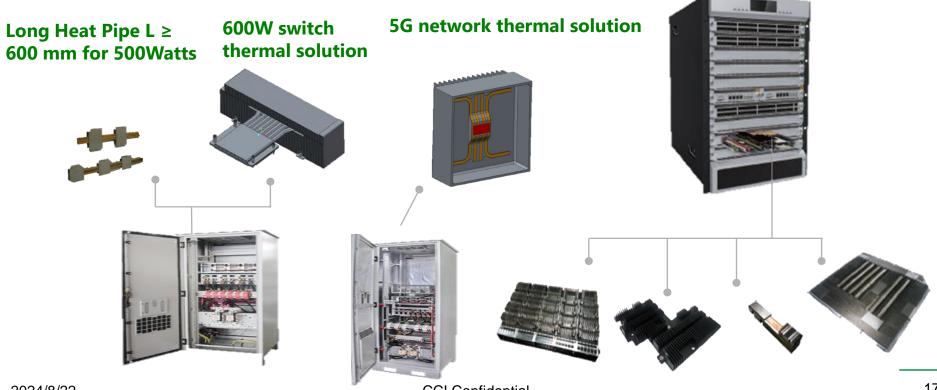




Application: 5G/6G/HPC







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Application: Automotive







Q & A

2024/8/22

